



**Data Sheet** 

September 2005

## Features

- · Internal control latches and address decoder
- Short setup and hold times
- Wide operating voltage: 4.5 V to 13.2 V
- 12 Vpp analog signal capability
- $R_{ON} 65 \Omega max. @ V_{DD} = 12 V, 25^{\circ}C$
- $\Delta R_{ON} \le 10 \ \Omega @ V_{DD} = 12 \ V, 25C$
- Full CMOS switch for low distortion
- Minimum feedthrough and crosstalk
- Low power consumption ISO-CMOS technology
- Internal pull-up resistor for RESET pin

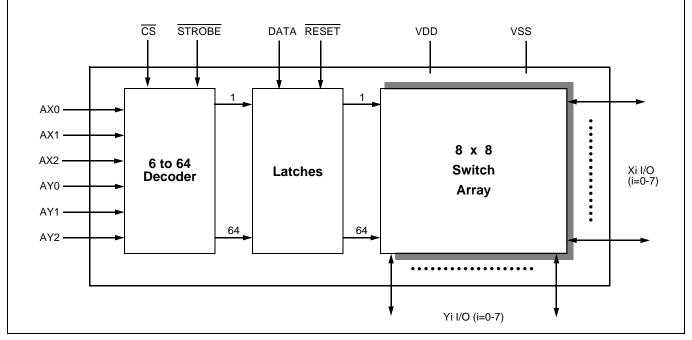
# Applications

- Key systems
- PBX systems
- Mobile radio
- Test equipment/instrumentation
- Analog/digital multiplexers
- Audio/Video switching

Ordering Information									
MT8809AE MT8809AP MT8809APR MT8809AP1 MT8809APR1 MT8809AE1	28 Pin PDIP 28 Pin PLCC 28 Pin PLCC 28 Pin PLCC* 28 Pin PLCC* 28 Pin PDIP*	Tubes Tubes Tape & Reel Tubes Tape & Reel Tubes							
* Pb Free Matte Tin									
	-40°C to +85°C								

## Description

The Zarlink MT8809 is fabricated in Zarlink's ISO-CMOS technology providing low power dissipation and high reliability. The device contains a 8 x 8 array of crosspoint switches along with a 6 to 64 line decoder and latch circuits. Any one of the 64 switches can be addressed by selecting the appropriate six address bits. The selected switch can be turned on or off by applying a logical one or zero to the DATA input. Chip Select (CS) allows the crosspoint array to be cascaded for matrix expansion.

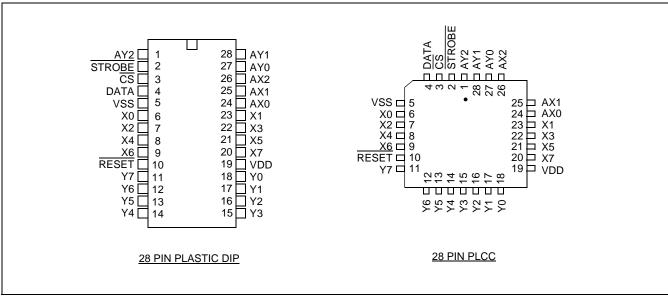


### Figure 1 - Functional Block Diagram

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#### **Pin Description**

Pin #	Name	Description
1	AY2	AY2 Address Line (Input).
2	STROBE	<b>STROBE (Input):</b> enables function selected by address and data. Address must be stable before STROBE goes low and DATA must be stable on the rising edge of STROBE. Active Low.
3	CS	Chip Select (Input): this is used to select the device. Active Low.
4	DATA	<b>DATA (Input)</b> : a logic high input will turn on the selected switch and a logic low will turn off the selected switch. Active High.
5	V <sub>SS</sub>	Ground Reference.
6-9	X0, X2, X4, X6	<b>X0, X2, X4 and X6 Analog (Inputs/Outputs):</b> these are connected to the X0, X2, X4 and X6 rows of the switch array.
10	RESET	<b>Master RESET (Input):</b> this is used to turn off all switches regardless of the condition of CS. A 100 k $\Omega$ internal pull-up resistor is also provided. This can be used in conjunction with a 0.1 $\mu$ F capacitor (connected to the RESET pin) to perform power-on reset of the device. Active Low.
11-18	Y7 - Y0	<b>Y7 - Y0 Analog (Inputs/Outputs):</b> these are connected to the Y0 - Y7 columns of the switch array.
19	V <sub>DD</sub>	Positive Power Supply.
20-23	X7, X5, X3, X1	<b>X7, X5, X3 and X1 Analog (Inputs/Outputs):</b> these are connected to the X7, X5, X3 and X1 rows of the switch array.
24-26	AX0-AX2	AX0 - AX2 Address Lines (Inputs).
27, 28	AY0, AY1	AY0 and AY1 Address Lines (Inputs).

# **Functional Description**

The MT8809 is an analog switch matrix with an array size of 8 x 8. The switch array is arranged such that there are 8 columns by 8 rows. The columns are referred to as the Y inputs/outputs and the rows are the X inputs/outputs. The crosspoint analog switch array will interconnect any X I/O with any Y I/O when turned on and provide a high degree of isolation when turned off. The control memory consists of a 64 bit write only RAM in which the bits are selected by the address inputs (AY0-AY2, AX0-AX2). Data is presented to the memory on the DATA input. Data is asynchronously written into memory whenever both the CS (Chip Select) and STROBE inputs are low and are latched on the rising edge of STROBE. A logical "1" written into a memory cell turns the corresponding crosspoint switch on and a logical "0" turns the crosspoint off. Only the crosspoint switches retain their previous states. Any combination of X and Y inputs/outputs can be interconnected by establishing appropriate patterns in the control memory. A logical "0" on the RESET input will asynchronously return all memory locations to logical "0" turning off all crosspoint switches regardless of whether CS is high or low.

# Address Decode

The six address inputs along with the  $\overline{\text{STROBE}}$  and  $\overline{\text{CS}}$  (Chip Select) are logically ANDed to form an enable signal for the resettable transparent latches. The DATA input is buffered and is used as the input to all latches. To write to a location, RESET must be high and  $\overline{\text{CS}}$  must go low while the address and data are set up. Then the  $\overline{\text{STROBE}}$  input is set low and then high causing the data to be latched. The data can be changed while  $\overline{\text{STROBE}}$  is low, however, the corresponding switch will turn on and off in accordance with the DATA input. DATA must be stable on the rising edge of  $\overline{\text{STROBE}}$  in order for correct data to be written to the latch.

	<b>0 0 1 0</b>				
	Parameter	Symbol	Min.	Max.	Units
1	Supply Voltage	V <sub>DD</sub> V <sub>SS</sub>	-0.3 -0.3	15.0 V <sub>DD</sub> +0.3	V V
2	Analog Input Voltage	V <sub>INA</sub>	-0.3	V <sub>DD</sub> +0.3	V
3	Digital Input Voltage	V <sub>IN</sub>	V <sub>SS</sub> -0.3	V <sub>DD</sub> +0.3	V
4	Current on any I/O Pin	I		±15	mA
5	Storage Temperature	Τ <sub>S</sub>	-65	+150	°C
6	Package Power Dissipation PLASTIC DIP	P <sub>D</sub>		0.6	W

Absolute Maximum Ratings\*- Voltages are with respect to V<sub>SS</sub> unless otherwise stated.

\* Exceeding these values may cause permanent damage. Functional operation under these conditions is not implied.

#### Recommended Operating Conditions - Voltages are with respect to V<sub>SS</sub> unless otherwise stated.

	Characteristics	Sym.	Min.	Тур.	Max.	Units	Test Conditions
1	Operating Temperature	Т <sub>О</sub>	-40	25	85	°C	
2	Supply Voltage	V <sub>DD</sub>	4.5		13.2	V	
3	Analog Input Voltage	V <sub>INA</sub>	$V_{SS}$		V <sub>DD</sub>	V	
4	Digital Input Voltage	V <sub>IN</sub>	$V_{SS}$		V <sub>DD</sub>	V	

## **DC Electrical Characteristics**<sup>†</sup>- Voltages are with respect to $V_{SS} = 0 V$ , $V_{DD} = 12 V$ unless otherwise stated.

	Characteristics	Sym.	Min.	Typ.‡	Max.	Units	Test Conditions
1	Quiescent Supply Current	I <sub>DD</sub>		1	100	μΑ	All digital in <u>puts at V<sub>IN</sub> = V<sub>SS</sub></u> V <sub>DD</sub> except RESET = V <sub>DD.</sub>
				120	400	μA	All digital inputs at $V_{IN} = V_{SS}$ or $V_{DD}$ except RESET = $V_{SS}$ .
				0.5	1.6	mA	All digital inputs at $V_{IN} = 2.4 \text{ V}$ , $V_{DD} = 5.0 \text{ V}$
				5	15	mA	All digital inputs at $V_{IN} = 3.4 \text{ V}$
2	Off-state Leakage Current (See G.9 in Appendix)	I <sub>OFF</sub>		±1	±500	nA	IV <sub>Xi</sub> - V <sub>Yj</sub> I = V <sub>DD</sub> - V <sub>SS</sub> See Appendix, Fig. A.1
3	Input Logic "0" level	V <sub>IL</sub>			0.8	V	
4	Input Logic "1" level	V <sub>IH</sub>	3.0			V	
6	Input Leakage (digital pins)	I <sub>LEAK</sub>		0.1	10	μA	All digital inputs at V <sub>IN</sub> = V <sub>SS</sub> or V <sub>DD;</sub> RESET = V <sub>DD</sub>

DC Electrical Characteristics are over recommended temperature range.
Typical figures are at 25°C and are for design aid only; not guaranteed and not subject to production testing.

	Characteristics	Sym.	25	5°C	70	°C	85	85°C		Test Conditions
			Тур.	Max.	Тур.	Max.	Тур.	Max.		
1	On-state $V_{DD} = 12 V$ Resistance $V_{DD} = 10V$ $V_{DD} = 5V$ (See G.1, G.2, G.3 in Appendix)	R <sub>ON</sub>	45 55 120	65 75 185		75 85 215		80 90 225	Ω Ω Ω	$\label{eq:VSS} \begin{array}{l} V_{SS} = 0 \ V, V_{DC} = V_{DD}/2, \\ IV_{Xi}\text{-}V_{Yj}\text{I} = 0.4 \ V \\ \text{See Appendix, Fig. A.2} \end{array}$
2	Difference in on-state resistance between two switches (See G.4 in Appendix)	ΔR <sub>O</sub> N	5	10		10		10	Ω	$\begin{split} V_{DD} &= 12 \text{ V},  \text{V}_{SS} = 0, \\ V_{DC} &=  \text{V}_{DD}/2, \\ \text{IV}_{Xi}\text{-}\text{V}_{Yj}\text{I} &= 0.4 \text{ V} \\ \text{See Appendix, Fig. A.2} \end{split}$

DC Electrical Characteristics- Switch Resistance - V<sub>DC</sub> is the external DC offset applied at the analog I/O pins.

# AC Electrical Characteristics<sup>†</sup> - Crosspoint Performance- $V_{DC}$ is the external DC offset at the analog I/O pins. Voltages are with respect to $V_{DD} = 5 \text{ V}$ , $V_{DC} = 0 \text{ V}$ , $V_{SS} = -7 \text{ V}$ , unless otherwise stated.

	Characteristics	Sym.	Min.	Typ.‡	Max.	Units	Test Conditions
1	Switch I/O Capacitance	C <sub>S</sub>		20		pF	f = 1 MHz
2	Feedthrough Capacitance	C <sub>F</sub>		0.2		pF	f = 1 MHz
3	Frequency Response Channel "ON" 20LOG(V <sub>OUT</sub> /V <sub>Xi</sub> )=-3 dB	F <sub>3dB</sub>		45		MHz	Switch is "ON"; $V_{INA} = 2 Vpp$ sinewave; $R_L = 1 k\Omega$ See Appendix, Fig. A.3
4	Total Harmonic Distortion (See G.5, G.6 in Appendix)	THD		0.01		%	Switch is "ON"; $V_{INA} = 2 Vpp$ sinewave f = 1 kHz; $R_L = 1 k\Omega$
5	Feedthrough Channel "OFF" Feed.=20LOG (V <sub>OUT</sub> /V <sub>Xi</sub> ) (See G.8 in Appendix)	FDT		-95		dB	All Switches "OFF"; $V_{INA}$ = 2Vpp sinewave f = 1 kHz; $R_L$ = 1 k $\Omega$ . See Appendix, Fig. A.4
6	Crosstalk between any two channels for switches Xi-Yi and	X <sub>talk</sub>		-45		dB	$V_{INA}$ = 2Vpp sinewave f = 10 MHz; R <sub>L</sub> = 75 Ω.
	$X_j$ - $Y_j$ .			-90		dB	$V_{INA}$ = 2Vpp sinewave f = 10kHz; R <sub>L</sub> = 600 Ω.
	Xtalk=20LOG (V <sub>Yj</sub> /V <sub>Xi</sub> ). (See G.7 in Appendix).			-85		dB	$V_{INA}$ =2Vpp sinewave f = 10 kHz; R <sub>L</sub> = 1 kΩ.
				-80		dB	$V_{INA} = 2Vpp sinewave$ f = 1 kHz; R <sub>L</sub> = 10 k $\Omega$ . Refer to Appendix, Fig. A.5 for test circuit.
7	Propagation delay through switch	t <sub>PS</sub>			30	ns	$R_L = 1 \text{ k}\Omega; C_L = 50 \text{ pF}$

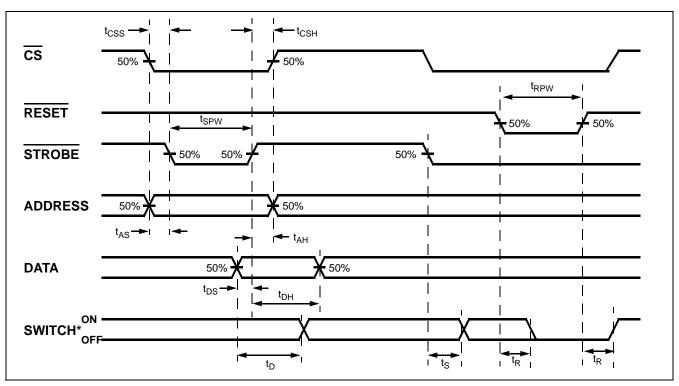
† Timing is over recommended temperature range. See Fig. 3 for control and I/O timing details.
‡ Typical figures are at 25°C and are for design aid only; not guaranteed and not subject to production testing.

Crosstalk measurements are for Plastic DIPS only, crosstalk values for PLCC packages are approximately 5 dB better.

	Characteristics	Sym.	Min.	Typ.‡	Max.	Units	Test Conditions
1	Con <u>trol</u> Input cr <u>osstalk to</u> switch (for CS, DATA, STROBE, Address)	CX <sub>talk</sub>		30		mVpp	$V_{IN}$ =3V+V <sub>DC</sub> squarewave; R <sub>IN</sub> =1 k $\Omega$ , R <sub>L</sub> =1 k $\Omega$ . See Appendix, Fig. A.6
2	Digital Input Capacitance	C <sub>DI</sub>		10		pF	f = 1 MHz
3	Switching Frequency	Fo			20	MHz	
4	Setup Time DATA to STROBE	t <sub>DS</sub>	10			ns	R <sub>L</sub> = 1 kΩ, C <sub>L</sub> = 50 pF ¿Å
5	Hold Time DATA to STROBE	t <sub>DH</sub>	10			ns	R <sub>L</sub> = 1 kΩ, C <sub>L</sub> = 50 pF Å <sub>ċ</sub>
6	Setup Time Address to STROBE	t <sub>AS</sub>	10			ns	$R_L$ = 1 kΩ, $C_L$ = 50 pF Å <sub>i</sub>
7	Hold Time Address to STROBE	t <sub>AH</sub>	10			ns	$R_L$ = 1 kΩ, $C_L$ = 50 pF Å <sub>i</sub>
8	Setup Time CS to STROBE	t <sub>CSS</sub>	10			ns	R <sub>L</sub> = 1 kΩ, C <sub>L</sub> = 50 pF Å <sub>ċ</sub>
9	Hold Time CS to STROBE	t <sub>CSH</sub>	10			ns	R <sub>L</sub> = 1 kΩ, C <sub>L</sub> = 50 pF ¿Å
10	STROBE Pulse Width	t <sub>SPW</sub>	20			ns	R <sub>L</sub> = 1 kΩ, C <sub>L</sub> = 50 pF ¿Å
11	RESET Pulse Width	t <sub>RPW</sub>	40			ns	R <sub>L</sub> = 1 kΩ, C <sub>L</sub> = 50 pF Å <sub>ζ</sub>
12	STROBE to Switch Status Delay	t <sub>S</sub>		40	100	ns	R <sub>L</sub> = 1 kΩ, C <sub>L</sub> =50 pF Å <sub>ċ</sub>
13	DATA to Switch Status Delay	t <sub>D</sub>		50	100	ns	R <sub>L</sub> = 1 kΩ, C <sub>L</sub> = 50 pF Å <sub>ċ</sub>
14	RESET to Switch Status Delay	t <sub>R</sub>		35	100	ns	R <sub>L</sub> = 1 kΩ, C <sub>L</sub> = 50 pF ¿Å

**AC Electrical Characteristics**<sup>†</sup> - **Control and I/O Timings**-  $V_{DC}$  is the external DC offset applied at the analog I/O pins. Voltages are with respect to  $V_{DD} = 5 V$ ,  $V_{DC} = 0 V$ ,  $V_{SS} = -7 V$ , unless otherwise stated.

† Timing is over recommended temperature range. See Fig. 3 for control and I/O timing details. Digital Input rise time (tr) and fall time (tf) = 5 ns. ‡ Typical figures are at 25°C and are for design aid only; not guaranteed and not subject to production testing. ſRefer to Appendix, Fig. A.7 for test circuit.

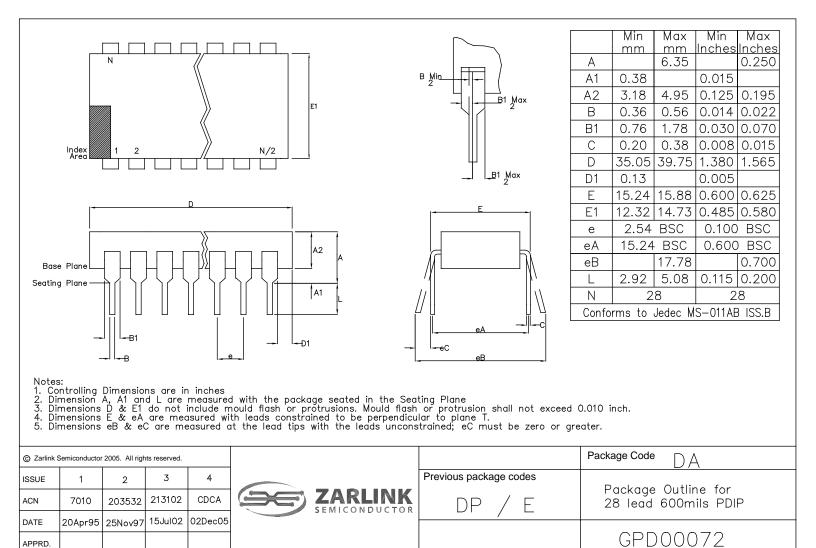


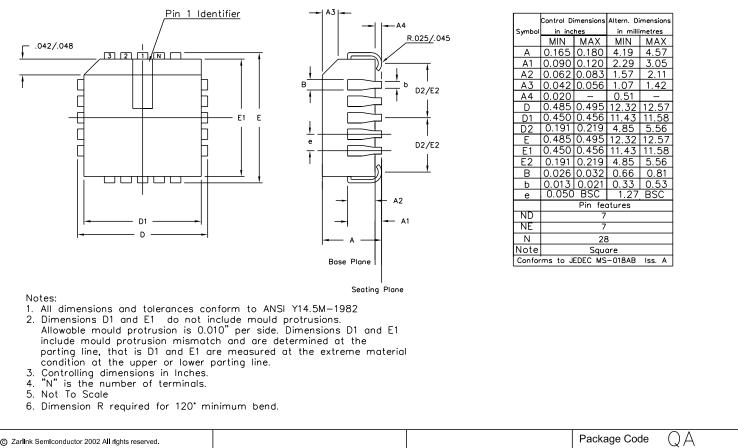
#### Figure 3 - Control Memory Timing Diagram

\* See Appendix, Fig. A.7 for switching waveform

AY2	AY1	AY0	AX2	AX1	AX0	Connection	AY2	AY1	AY0	AX2	AX1	AX0	Connection
0 0 0	0 0 0	0 0 0	0 0 0	0 0 1	0 1 0	X0 Y0 X1 Y0 X2 Y0	1 1 1	0 0 0	0 0 0	0 0 0	0 0 1	0 1 0	X0 Y4 X1 Y4 X2 Y4
0 0	0 0	0 0	0 1	1 0	1 0	X3 Y0 X4 Y0	1 1	0 0	0 0	0 1	1 0	1 0	X3 Y4 X4 Y4
0 0 0	0 0 0	0 0 0	1 1 1	0 1 1	1 0 1	X5 Y0 X6 Y0 X7 Y0	1 1 1	0 0 0	0 0 0	1 1 1	0 1 1	1 0 1	X5 Y4 X6 Y4 X7 Y4
0	0	1	0	0	0	X0 Y1	1	0	1	0	0	0	X0 Y5
0 0	0 0	1 1	0 0	0 1	1 0	X1 Y1 X2 Y1	1 1	0 0	1 1	0 0	0 1	1 0	X1 Y5 X2 Y5
0 0	0 0	1 1	0 1	1 0	1 0	X3 Y1 X4 Y1	1 1	0 0	1 1	0 1	1 0	1 0	X3 Y5 X4 Y5
0	0	1	1	0 1	1 0	X5 Y1 X6 Y1	1	0	1	1	0	1	X5 Y5 X6 Y5
0	0	1 0	1 0	1 0	1 0	X7 Y1 X0 Y2	1	0	1	1 0	1	1	X7 Y5 X0 Y6
0	1	0	0	0 1	0 1 0	X1 Y2 X2 Y2	1 1	1 1	0	0	0 1	1 0	X1 Y6 X2 Y6
0	1	0	0	1 0	1 0	X3 Y2 X4 Y2	1	1 1	0	0	1 0	1 0	X3 Y6 X4 Y6
0	1 1	0	1 1	0 1	1 0	X5 Y2 X6 Y2	1 1	1 1	0	1 1	0 1	1 0	X5 Y6 X6 Y6
0	1	0	1	1	1	X7 Y2	1	1	0	1	1	1	X7 Y6
0	1	1	0 0	0	0 1	X0 Y3 X1 Y3	1	1	1	0 0	0	0 1	X0 Y7 X1 Y7
0 0 0	1 1 1	1 1 1	0 0 1	1 1 0	0 1 0	X2 Y3 X3 Y3 X4 Y3	1 1 1	1 1 1	1 1 1	0 0 1	1 1 0	0 1 0	X2 Y7 X3 Y7 X4 Y7
0	1	1 1	1	0 1	0 1 0	X5 Y3 X6 Y3	1 1	1	1	1	0 1	1 0	X5 Y7 X6 Y7
0	1	1	1	1	1	X7 Y3	1	1	1	1	1	1	X7 Y7

 Table 1 - Address Decode Truth Table





© Zarlink S	Semiconductor	2002 All right	s reserved.			Package Code QA
ISSUE	1	2	3		Previous package codes	Package Outline for
ACN	5958	207469	212422		HP / P	28 Jead PLCC
DATE	15Aug94	10Sep99	22Mar02	JEMICONDUCTOR	· · · · · · · · · · · · · · · · · · ·	
APPRD.						GPD00002



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